

MN4503B/MN4503BS

Hex Non-Inverting 3-State Buffer

■ Outline

The MN4503B/S is a non-inverting 3-state buffer to accept a large source current and a large sink current. It has two output enable inputs (\overline{EO}_2 , \overline{EO}_4) which can respectively control two circuits and four circuits independently. When the level of \overline{EO}_4 is set to "H", the outputs of the buffers 1~4 become the high impedance state, and when the level of \overline{EO}_2 was set to "H", the outputs of the buffer 5~6 become the high impedance state.

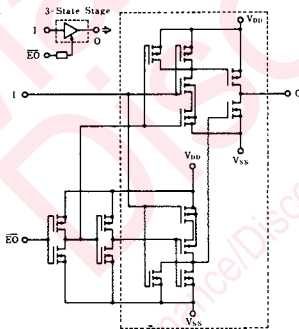
This non-inverting 3-state buffer is equivalent to Motorola's MC14503B.

■ Truth Table

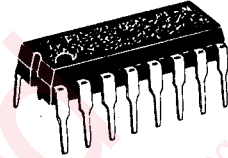
Input		Output
I	\overline{EO}	O
L	L	L
H	L	H
x	H	Z

Note) x : don't care Z : High impedance (OFF state)

■ Schematic Diagram



P-3



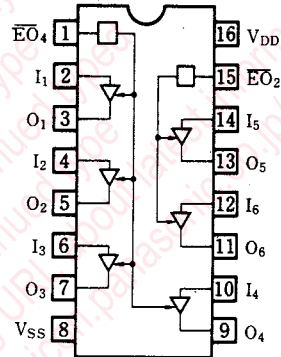
16-pin plastic DIL package

P-4



16-pin PANAFLAT package (SO-16D)

Pin Configuration



■ Absolute Maximum Ratings (Ta=25°C)

Item	Symbol	Rating	Unit
Supply voltage	V_{DD}	-0.5~+18	V
Input voltage	V_I	-0.5~ $V_{DD}+0.5^*$	V
Output pin voltage	V_O	-0.5~ $V_{DD}+0.5^*$	V
Peak input · output pin current	$\pm I_I$	max. 25	mA
Power dissipation (per package)	$T_a = -40 \sim +60^\circ\text{C}$	max. 400	mW
	$T_a = +60 \sim +80^\circ\text{C}$	Decrease to 200mW at the rate of 8mW/°C	
Power dissipation (per output pin)	P_D	max. 100	mW
Operating ambient temperature	T_{opr}	-40~+85	°C
Storage temperature	T_{stg}	-65~+150	°C

* $V_{DD}+0.5V$ should be lower than 18V.

■ DC Characteristics ($V_{SS}=0V$)

Item	V_{DD} (V)	Symbol	Condition	$T_a=-40^\circ C$		$T_a=25^\circ C$		$T_a=85^\circ C$		Unit	
				min.	max.	min.	max.	min.	max.		
Static supply current	5	I_{DD}	$V_I=V_{SS}$ or V_{DD}	—	4	—	4	—	30	μA	
	10			—	8	—	8	—	60		
	15			—	16	—	16	—	120		
Output voltage low level	5	V_{OL}	$V_I=V_{SS}$ or V_{DD} $ I_{O} <1\mu A$	—	0.05	—	0.05	—	0.05	V	
	10			—	0.05	—	0.05	—	0.05		
	15			—	0.05	—	0.05	—	0.05		
Output voltage high level	5	V_{OH}	$V_I=V_{SS}$ or V_{DD} $ I_{O} <1\mu A$	4.95	—	4.95	—	4.95	—	V	
	10			9.95	—	9.95	—	9.95	—		
	15			14.95	—	14.95	—	14.95	—		
Input voltage low level	5	V_{IL}	$ I_{O} <1\mu A$	$V_O=0.5V$ or $4.5V$	—	1.5	—	1.5	—	V	
	10			$V_O=1V$ or $9V$	—	3	—	3	—		3
	15			$V_O=1.5V$ or $13.5V$	—	4	—	4	—		4
Input voltage high level	5	V_{IH}	$ I_{O} <1\mu A$	$V_O=0.5V$ or $4.5V$	3.5	—	3.5	—	3.5	V	
	10			$V_O=1V$ or $9V$	7	—	7	—	7		—
	15			$V_O=1.5V$ or $13.5V$	11	—	11	—	11		—
Output current low level	4.75	I_{OL}	$V_O=0.4V, V_I=0$ or $5V$ $V_O=0.5V, V_I=0$ or $10V$ $V_O=1.5V, V_I=0$ or $15V$	1.7	—	1.4	—	1.1	—	mA	
	10			4.8	—	4	—	3.2	—		
	15			12	—	10	—	8	—		
Output current high level	5	$-I_{OH}$	$V_O=4.6V, V_I=0$ or $5V$ $V_O=9.5V, V_I=0$ or $10V$ $V_O=13.5V, V_I=0$ or $15V$	1	—	0.88	—	0.7	—	mA	
	10			2.4	—	2.2	—	1.8	—		
	15			6.6	—	6	—	4.8	—		
Output current high level	5	$-I_{OH}$	$V_O=2.5V, V_I=0$ or $5V$	1.7	—	1.4	—	1.1	—	mA	
Input leakage current	15	$\pm I_I$	$V_I=0$ or $15V$	—	0.3	—	0.3	—	1	μA	
3-state output pin	Leakage current high level	15	I_{OZH}	$V_O=V_{DD}$	—	1.6	—	1.6	—	12	μA
	Leakage current low level	15	$-I_{OZL}$	$V_O=V_{SS}$	—	1.6	—	1.6	—	12	

■ Switching Characteristics ($T_a=25^\circ C, V_{SS}=0V, C_L=50pF$)

Item	V_{DD} (V)	Symbol	min.	typ.	max.	Unit
Output rise time (Fig. 1)	5	t_{PLH}	—	35	105	ns
	10		—	20	60	
	15		—	15	45	
Output fall time (Fig. 1)	5	t_{THL}	—	30	90	ns
	10		—	15	45	
	15		—	10	30	
Propagation time (Fig. 1)	5	t_{PLH}	—	60	180	ns
	10		—	25	75	
	15		—	20	60	
Propagation time (Fig. 1)	5	t_{PHL}	—	70	210	ns
	10		—	30	90	
	15		—	25	75	
3-state propagation time (Fig. 2) O(H)→High impedance	5	t_{PHz}	—	45	135	ns
	10		—	35	105	
	15		—	30	90	
3-state propagation time O(L)→High impedance	5	t_{PLz}	—	60	180	ns
	10		—	35	105	
	15		—	25	75	

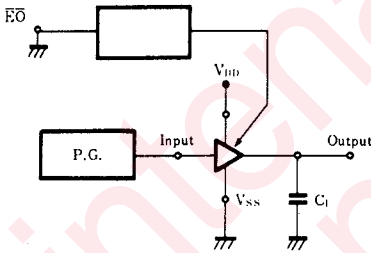
■ Switching Characteristics (cont.)

Item	V _{DD} (V)	Symbol	min.	typ.	max.	Unit
3-state propagation time (Fig. 2)	5		—	75	225	
High impedance→O(H)	10	t _{pZH}	—	35	105	ns
High impedance→O(L)	15		—	30	90	
3-state propagation time (Fig. 2)	5		—	95	285	
High impedance→O(L)	10	t _{pZL}	—	40	120	ns
High impedance→O(H)	15		—	30	90	
Input capacitance		C ₁	—	—	7.5	pF

● Switching time measuring circuit and waveforms

Fig. 1 t_{TLH}, t_{THL}, t_{PLH}, t_{PHL}

1. Switching time measuring circuit



2. Switching waveforms

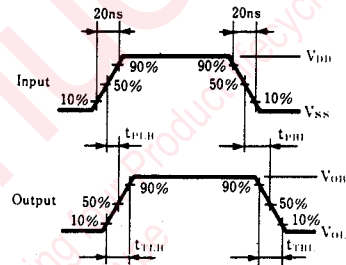
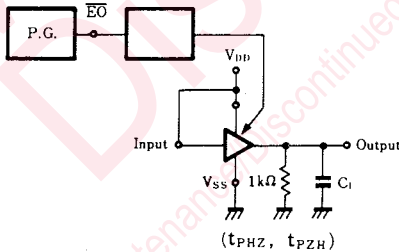
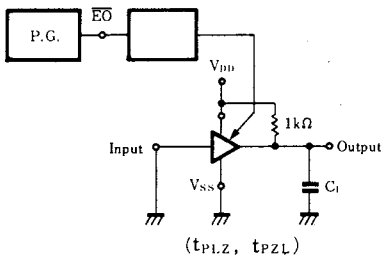
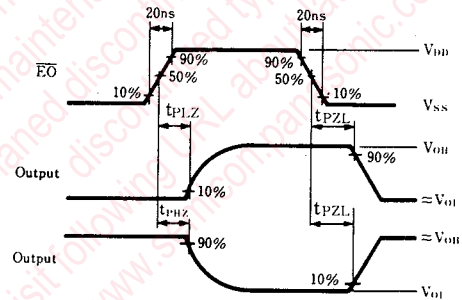


Fig. 2 t_{PHZ}, t_{PZH}, t_{PLZ}, t_{PZL}

1. Switching time measuring circuit



2. Switching waveforms



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